

Digital Comb Filter (NTSC/PAL)

Description

The CXD2064Q is an adaptive intra-field comb filter compatible with NTSC and PAL systems, and can provide high-precision Y/C separation with a single chip.

Features

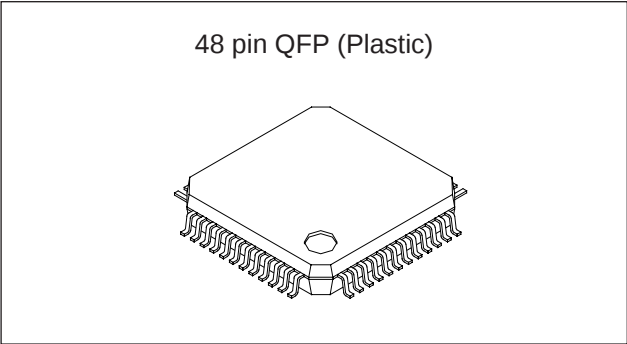
- Adaptive intra-field Y/C separation
- M-PAL and N-PAL supported
- Vertical enhancer
- Horizontal aperture correction
- 8-bit A/D converter (1-channel)
- 8-bit D/A converter (2-channel)
- 4× PLL
- Sync tip clamp
- Four 1H delay lines

Applications

Y/C separation for color TVs and VCRs

Structure

Silicon gate CMOS ICStructure



Absolute Maximum Ratings (Ta = 25°C, Vss = 0V)

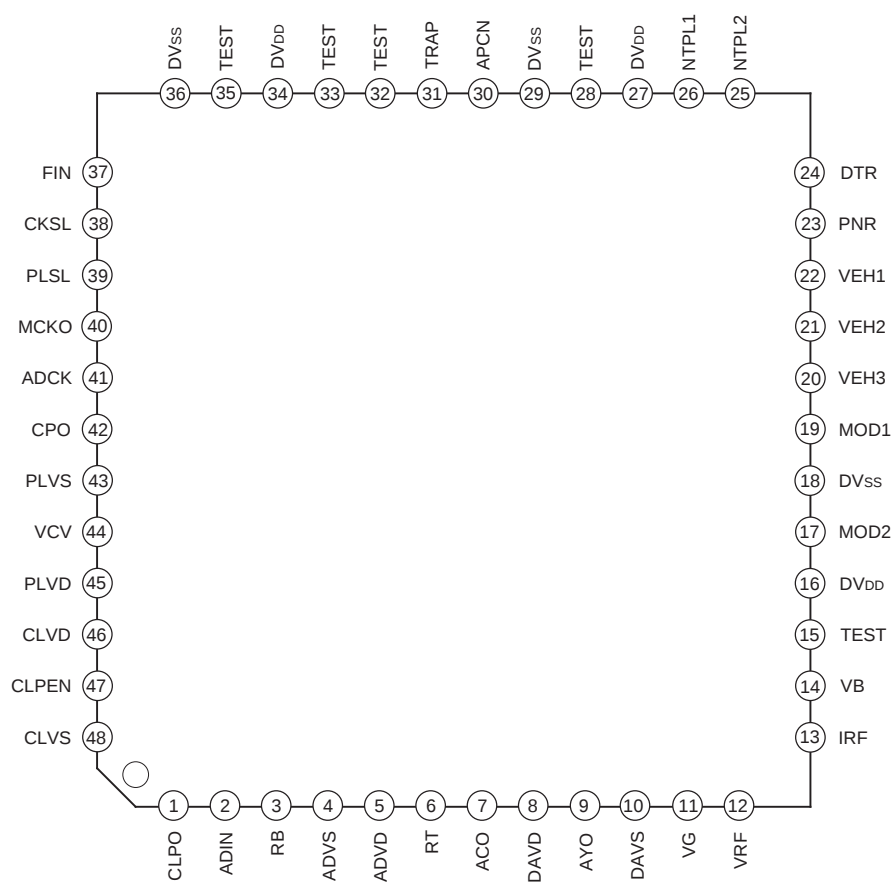
|                       |      |                        |    |
|-----------------------|------|------------------------|----|
| • Supply voltage      | DVDD | Vss – 0.5 to +7.0      | V  |
|                       | DAVD | Vss – 0.5 to +7.0      | V  |
|                       | ADVD | Vss – 0.5 to +7.0      | V  |
|                       | PLVD | Vss – 0.5 to +7.0      | V  |
|                       | CLVD | Vss – 0.5 to +7.0      | V  |
| • Input voltage       | Vi   | Vss – 0.5 to VDD + 0.5 | V  |
| • Output voltage      | Vo   | Vss – 0.5 to VDD + 0.5 | V  |
| • Storage temperature | Tstg | –55 to +150            | °C |

Recommended Operating Conditions

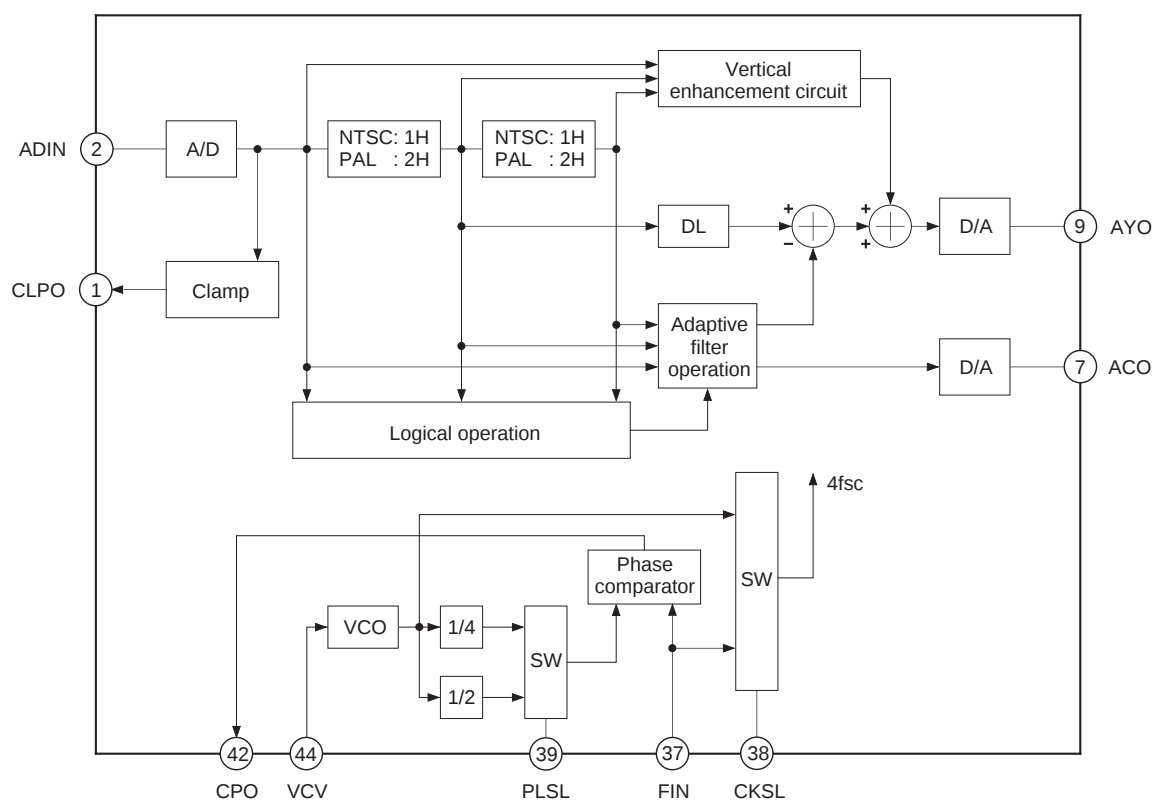
|                         |      |            |      |
|-------------------------|------|------------|------|
| • Supply voltage        | DVDD | 5.0 ± 0.25 | V    |
|                         | DAVD | 5.0 ± 0.25 | V    |
|                         | ADVD | 5.0 ± 0.25 | V    |
|                         | PLVD | 5.0 ± 0.25 | V    |
|                         | CLVD | 5.0 ± 0.25 | V    |
| • Analog input          | ADIN | 1.75       | Vp-p |
| • Operating temperature | Topr | –20 to +70 | °C   |

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## Pin Configuration



## Block Diagram



## Pin Description

| Pin No. | Symbol           | I/O | Description                                                                                                                                                                              |
|---------|------------------|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1       | CLPO             | O   | Internal clamp circuit current output.<br>Connect to ADIN when using the internal clamp.<br>Leave this pin open when not in use.                                                         |
| 2       | ADIN             | I   | Comb filter analog input (A/D converter input).                                                                                                                                          |
| 3       | RB               | O   | Reference bottom voltage for the A/D converter (0.52V typ.).                                                                                                                             |
| 4       | ADVS             | —   | A/D converter analog ground.                                                                                                                                                             |
| 5       | ADVD             | —   | A/D converter analog power supply. (5.0V)                                                                                                                                                |
| 6       | RT               | O   | Reference top voltage for the A/D converter (2.60V typ.).                                                                                                                                |
| 7       | ACO              | O   | Analog chroma signal output.<br>Output can be obtained by connecting a resistor between this pin and the analog ground.                                                                  |
| 8       | DAVD             | —   | D/A converter analog power supply. (5.0V)                                                                                                                                                |
| 9       | AYO              | O   | Analog luminance signal output.<br>Output can be obtained by connecting a resistor between this pin and the analog ground.                                                               |
| 10      | DAVS             | —   | D/A converter analog ground.                                                                                                                                                             |
| 11      | VG               | O   | D/A converter related pin. Connect a capacitor of approximately 0.1μF between this pin and the analog power supply (DAVD).                                                               |
| 12      | VRF              | I   | Sets the full-scale value of the Y and C-channel D/A converter output signal.                                                                                                            |
| 13      | IRF              | O   | Connect a resistor of “16R” (16 times the output resistor “R” of the D/A converter).                                                                                                     |
| 14      | VB               | O   | D/A converter related pin.<br>Connect to the analog ground (DAVS) via a capacitor of approximately 0.1μF.                                                                                |
| 15      | TEST             | I   | Test pin. Normally fix to “Low”.                                                                                                                                                         |
| 16      | DV <sub>DD</sub> | —   | Digital power supply. (5.0V)                                                                                                                                                             |
| 18      | DV <sub>SS</sub> | —   | Digital ground.                                                                                                                                                                          |
| 17      | MOD2             | I   | Y/C separation mode setting.<br><div> MOD2    MOD1<br/> L        L        Adaptive processing mode<br/> H        L        BPF separation mode<br/> H        H        Through mode </div> |
| 19      | MOD1             | I   |                                                                                                                                                                                          |
| 20      | VEH3             | I   |                                                                                                                                                                                          |
| 21      | VEH2             | I   | Vertical enhancement setting.<br>Can be set in 8 stages from VEH3 VEH2 VEH1: LLL (off) to HHH (max.)                                                                                     |
| 22      | VEH1             | I   |                                                                                                                                                                                          |
| 23      | PNR              | I   | L: NTSC/H: PAL, M-PAL, N-PAL                                                                                                                                                             |
| 24      | DTR              | I   | Normally fix to “Low”.                                                                                                                                                                   |
| 25      | NTPL2            | I   | NTSC/PAL/M-PAL/N-PAL mode setting.<br><div> NTPL2    NTPL1<br/> L        L        NTSC<br/> L        H        PAL<br/> H        L        M-PAL<br/> H        H        N-PAL </div>       |
| 26      | NTPL1            | I   |                                                                                                                                                                                          |
| 27      | DV <sub>DD</sub> | —   |                                                                                                                                                                                          |

| Pin No. | Symbol           | I/O | Description                                                                                                                                                                                                    |
|---------|------------------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 28      | TEST             | I   | Test pin. Normally fix to "Low".                                                                                                                                                                               |
| 29      | DV <sub>SS</sub> | —   | Digital ground.                                                                                                                                                                                                |
| 30      | APCN             | I   | Horizontal aperture correction circuit setting. Low: Off, High: On.                                                                                                                                            |
| 31      | TRAP             | I   | Trap filter setting. Low: Off, High: On.                                                                                                                                                                       |
| 32      | TEST             | I   | Test pin. Normally open or fix to "Low".                                                                                                                                                                       |
| 33      | TEST             | I   | Test pin. Normally open or fix to "Low".                                                                                                                                                                       |
| 34      | DV <sub>DD</sub> | —   | Digital power supply. (5.0V)                                                                                                                                                                                   |
| 35      | TEST             | I   | Test pin. Normally open or fix to "Low".                                                                                                                                                                       |
| 36      | DV <sub>SS</sub> | —   | Digital ground.                                                                                                                                                                                                |
| 37      | FIN              | I   | Clock input. Input the burst-locked fsc (2fsc) when using the internal PLL. Input the burst-locked 4fsc when not using the internal PLL.                                                                       |
| 38      | CKSL             | I   | PLL control.<br>Low: The internal PLL is not used. The clock (4fsc) which is input to FIN is supplied internally.<br>High: The internal PLL is used. VCO oscillation output 4fsc clock is supplied internally. |
| 39      | PLSL             | I   | Selects the clock input to FIN. Low: fsc, High: 2fsc.<br>When inputting 4fsc to FIN (when not using the internal PLL), this pin may be set to either "Low" or "High".                                          |
| 40      | MCKO             | O   | Clock (4fsc) output.                                                                                                                                                                                           |
| 41      | ADCK             | I   | Clock input for A/D converter. Normally connect to MCKO.                                                                                                                                                       |
| 42      | CPO              | O   | PLL phase comparator output. Leave open when not using the PLL.                                                                                                                                                |
| 43      | PLVS             | —   | PLL analog ground.                                                                                                                                                                                             |
| 44      | VCV              | I   | VCO control voltage input. Connect to PLVS when not using the PLL.                                                                                                                                             |
| 45      | PLVD             | —   | PLL analog power supply. (5.0V)                                                                                                                                                                                |
| 46      | CLVD             | —   | Clamp D/A converter analog power supply. (5.0V)                                                                                                                                                                |
| 47      | CLPEN            | I   | Clamp circuit enable pin. Low: Clamp on, High: Clamp off.                                                                                                                                                      |
| 48      | CLVS             | —   | Clamp D/A converter analog ground.                                                                                                                                                                             |

## Electrical Characteristics

## DC Characteristics

(V<sub>DD</sub> = 4.75 to 5.25V, V<sub>SS</sub> = 0V, T<sub>a</sub> = -20 to +70°C)

| Item                         | Symbol                            | Measurement conditions                               | Min.                  | Typ. | Max.               | Unit | Applicable pins |
|------------------------------|-----------------------------------|------------------------------------------------------|-----------------------|------|--------------------|------|-----------------|
| Supply voltage               | DV <sub>DD</sub>                  | —                                                    | 4.75                  | 5.0  | 5.25               | V    | *1              |
|                              | DAVD                              |                                                      |                       |      |                    |      |                 |
|                              | ADVD                              |                                                      |                       |      |                    |      |                 |
|                              | PLVD                              |                                                      |                       |      |                    |      |                 |
|                              | CLVD                              |                                                      |                       |      |                    |      |                 |
| Operating temperature        | Topr                              | —                                                    | −20                   |      | +70                | °C   |                 |
| Supply current               | I <sub>DD</sub>                   | Clock 18MHz                                          | —                     | 90   | —                  | mA   | —               |
| Input/output voltage         | V <sub>I</sub> , V <sub>O</sub>   | —                                                    | V <sub>SS</sub>       |      | V <sub>DD</sub>    | V    | *2              |
| Input voltage                | V <sub>IH</sub>                   | CMOS level input                                     | 0.7V <sub>DD</sub>    |      |                    | V    | *3              |
|                              | V <sub>IL</sub>                   |                                                      |                       |      | 0.3V <sub>DD</sub> |      |                 |
| Input rise/fall time         | tr, tf                            | —                                                    | 0                     |      | 500                | ns   | *1              |
| Output voltage               | V <sub>OH</sub>                   | I <sub>OH</sub> = −2mA                               | V <sub>DD</sub> − 0.8 |      |                    | V    | *4              |
|                              |                                   | I <sub>OH</sub> = −3mA                               |                       |      |                    |      | *5              |
|                              | V <sub>OL</sub>                   | I <sub>OL</sub> = 4mA                                |                       |      | 0.4                |      | *4              |
|                              |                                   | I <sub>OL</sub> = 1.5mA                              |                       |      |                    |      | *5              |
| Clock input amplitude        | V <sub>IN</sub>                   | fmax = 50MHz sine wave                               | 0.5                   |      |                    | Vp-p | *6              |
| Feedback resistance value    | R <sub>FB</sub>                   | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>DD</sub> | 250k                  | 1M   | 2.5M               | Ω    |                 |
| Input leak current           | I <sub>IL</sub> , I <sub>IH</sub> | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>DD</sub> | −10                   |      | 10                 | μA   | *7              |
|                              | I <sub>IH</sub>                   | V <sub>IH</sub> = V <sub>DD</sub>                    | 40                    | 100  | 240                |      | *8              |
| Clock amplifier output delay | —                                 | —                                                    | 3.0                   | 9.0  | 18.0               | ns   | *9              |

\*1 All pins

\*2 All pins other than \*6

\*3 All input pins other than \*6

\*4 All output pins other than \*5

\*5 CPO (Pin 42)

\*6 FIN (Pin 37)

\*7 All input pins other than \*8

\*8 Pins 32, 33 and 35

\*9 MCKO (Pin 40)

**I/O Pin Capacitance**

(Ta = 25°C, f = 1MHz, VIN = VOUT = 0V)

| Item                   | Symbol | Min. | Min. | Max. | Unit |
|------------------------|--------|------|------|------|------|
| Input pin capacitance  | CIN    | —    | —    | 9    | pF   |
| Output pin capacitance | COUT   | —    | —    | 11   |      |

**Internal 8-bit A/D Converter Characteristics**

(VDD = 5V, Ta = 25°C, f = 10MHz)

| Item                         | Symbol    | Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|-----------|------------|------|------|------|------|
| Resolution                   | n         |            | —    | 8    | —    | bit  |
| Max. conversion speed        | fmax      |            | 18   | —    | —    | MSPS |
| Analog input bandwidth       | BW        | −3dB       | —    | 18   | —    | MHz  |
| Self bias                    | VRB       |            | 0.48 | 0.52 | 0.56 | V    |
|                              | VRT − VRB |            | 1.96 | 2.08 | 2.22 | V    |
| Output data delay            | tpd       |            | —    | —    | 45   | ns   |
| Differential linearity error | ED        |            | −1.0 | —    | +1.0 | LSB  |
| Integral linearity error     | EL        |            | −2.0 | —    | +2.0 | LSB  |

**Internal 8-bit D/A Converter Characteristics**

(VDD = 5V, VRF = 2V, RIRF = 3.3kΩ, R = 200Ω, Ta = 25°C, f = 10MHz)

| Item                         | Symbol | Conditions               | Min.  | Typ. | Max.  | Unit |
|------------------------------|--------|--------------------------|-------|------|-------|------|
| Resolution                   | n      |                          | —     | 8    | —     | bit  |
| Max. conversion speed        | fmax   |                          | 18    | —    | —     | MSPS |
| Differential linearity error | ED     |                          | −0.8  | —    | +0.8  | LSB  |
| Integral linearity error     | EL     |                          | −2.0  | —    | +2.0  | LSB  |
| Output full-scale voltage    | VFS    |                          | 1.805 | 1.90 | 1.995 | V    |
| Output full-scale current    | IFS    |                          | —     | 9.5  | 15    | mA   |
| Output offset voltage        | Vos    |                          | —     | —    | 1.0   | mV   |
| Glitch energy                | GE     | R = 75Ω,<br>1Vp-p output | —     | 30   | —     | pV-s |

**Internal Clamp**

(VDD = 5V, Ta = 25°C, f = 10MHz)

| Item           | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|----------------|--------|------------|------|------|------|------|
| Clamp level *1 | CLV    |            | —    | 0.67 | —    | V    |

\*1 Sync tip clamp

## Description of Functions

- Y/C separation mode

The Y/C separation mode can be switched by the following pin settings.

| Mode name                | MOD2 (Pin 17) | MOD1 (Pin 19) |
|--------------------------|---------------|---------------|
| Adaptive processing mode | L             | L             |
| BPF separation mode      | H             | L             |
| Through mode             | H             | H             |

Adaptive processing mode:

Y/C separation is performed by detecting the correlation between three lines and switching between comb filter and BPF processing.

BPF separation mode:

Y/C separation is performed only by BPF processing.

Through mode:

The composite video signal input from ADIN (Pin 2) is A/D converted and then D/A converted without modification. D/A outputs are AYO (Pin 9) and ACO (Pin 7).

- Horizontal aperture correction circuit

This circuit corrects the frequency response degradation caused by the aperture effects accompanying D/A conversion. This circuit is valid in the adaptive processing and BPF separation modes noted above.

- Trap filter circuit

A trap filter is applied to remove the frequency components near fsc in the luminance signal after Y/C separation.

This reduces the fsc frequency component gain by approximately 2.5dB.

This circuit is valid in the adaptive processing and BPF separation modes noted above.

- Using the internal PLL (clock selection method)

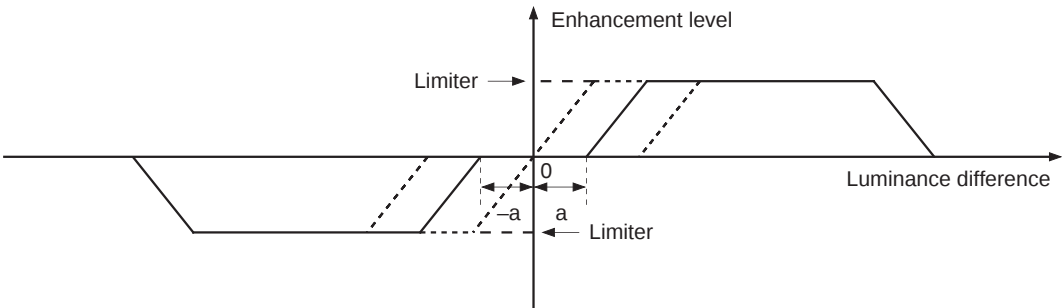
|              | FIN (Pin 37) | CKSL (Pin 38) | PLSL (Pin 39) |
|--------------|--------------|---------------|---------------|
| PLL used     | fsc input    | H             | L             |
|              | 2fsc input   | H             | H             |
| PLL not used | 4fsc input   | L             | L/H           |

• Vertical enhancement circuit

This circuit generates an enhanced component in accordance with the vertical aperture component (luminance difference from the preceding and following lines) of the luminance signal. The vertical aperture of the picture can be enhanced naturally by adding this enhanced component to the luminance signal after Y/C separation.

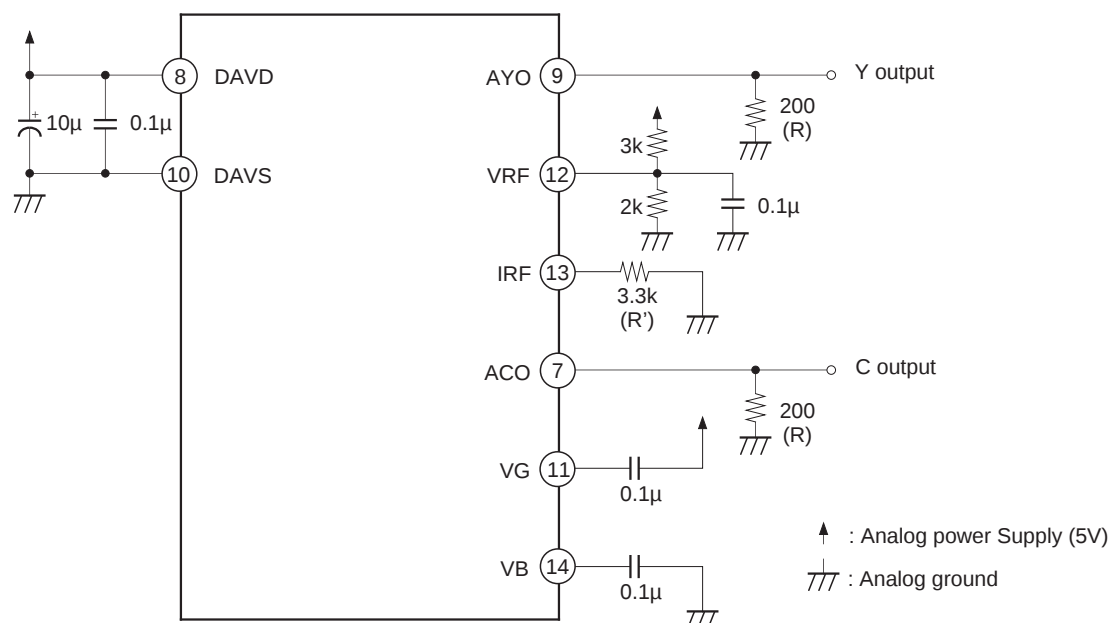
The enhancement level can be set in eight steps. The size of  $|a|$  in the figure below varies according to the pin settings. Accordingly, enhanced level can be changed for portions of natural pictures with small luminance differences where the effects are particularly easy to see.

Portions with large luminance differences are cut with a limiter so that they are not excessively enhanced. Also, portions with extremely large luminance differences such as white and black lines are not enhanced because they need be enhanced any more.



| Enhancement level | Pin settings     |                  |                  | $ a $      |
|-------------------|------------------|------------------|------------------|------------|
|                   | VEH3<br>(Pin 20) | VEH2<br>(Pin 21) | VEH1<br>(Pin 22) |            |
| OFF               | L                | L                | L                | —          |
| 1                 | L                | L                | H                | Large<br>↑ |
| 2                 | L                | H                | L                |            |
| 3                 | L                | H                | H                |            |
| 4                 | H                | L                | L                |            |
| 5                 | H                | L                | H                | ↓<br>Small |
| 6                 | H                | H                | L                |            |
| Max               | H                | H                | H                |            |

## Application Circuit for D/A Converter Block



- Method of selecting the output resistor

The CXD2064Q has a built-in current output type D/A converter. To obtain the output voltages, connect resistors to the AYO and ACO pins.

The specs are as follows: output full-scale voltage  $V_{FS} = 0.5$  to  $2.0$  [V], output full-scale current  $I_{FS} = 0$  to  $15$  [mA].

Calculate the output resistance value using the relationship  $V_{FS} = I_{FS} \times R$ . In addition, connect a resistor of 16 times the output resistor to the reference current pin (IRF). In case this results in a unpractical value, use a resistance value as close to the calculated value as possible.

Note that, at this time,  $V_{FS} = V_{RF} \times 16R/R'$  ( $V_{RF}$ : Pin voltage of  $V_{RF}$ ). Here,  $R$  is the resistor connected to AYO/ACO, and  $R'$  is the resistor connected to IRF.

Power consumption can be reduced by using higher resistance values, but the glitch energy and data settling time increase contrastingly. Set the optimum values according to the system applications.

- $V_{DD}$ ,  $V_{SS}$

Separate the analog and digital systems around the device to reduce the effects of noise. DAVD is bypassed to DAVS as close to each other as possible through a ceramic capacitor of approximately  $0.1\mu\text{F}$ .

Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

**Legend:**

- ↑ : Analog power Supply (5V)
- ⏏ : Analog ground
- ⏏ : Digital power Supply (5V)
- ⏏ : Digital ground
- H : CMOS High level
- L : CMOS Low level

**Pin Connections:**

- Pin 37:** Clock Input, connected to a 0.001μF capacitor.
- Pin 38:** CKSL, connected to a switch (H/L).
- Pin 39:** PLSL, connected to a switch (H/L).
- Pin 40:** MCKO, connected to pin 41.
- Pin 41:** ADCK, connected to pin 40.
- Pin 42:** CPO, connected to a 560Ω resistor and a 56kΩ resistor.
- Pin 43:** PLVS, connected to a 0.022μF capacitor.
- Pin 44:** VCV, connected to a 0.1μF capacitor.
- Pin 45:** PLVD, connected to a 0.1μF capacitor.
- Pin 46:** CLVD, connected to a 0.1μF capacitor.
- Pin 47:** CLPEN, connected to a switch (H/L).
- Pin 48:** CLVPO, connected to pin 1.
- Pin 1:** CLPO, connected to pin 48.
- Pin 2:** ADIN, connected to a 0.1μF capacitor.
- Pin 3:** RB, connected to a 0.1μF capacitor.
- Pin 4:** ADVS, connected to a 0.1μF capacitor.
- Pin 5:** ADVD, connected to a 0.1μF capacitor.
- Pin 6:** RT, connected to a 0.1μF capacitor.
- Pin 7:** ACO, connected to a 200Ω resistor.
- Pin 8:** DAVID, connected to a 0.1μF capacitor.
- Pin 9:** AYO, connected to a 200Ω resistor.
- Pin 10:** DAVS, connected to a 0.1μF capacitor.
- Pin 11:** VG, connected to a 0.1μF capacitor.
- Pin 12:** VRF, connected to a 3kΩ resistor and a 0.1μF capacitor.
- Pin 13:** IRF, connected to a 3.3kΩ resistor.
- Pin 14:** VB, connected to a 0.1μF capacitor.
- Pin 15:** TEST, connected to ground.
- Pin 16:** DVDD, connected to a 0.1μF capacitor.
- Pin 17:** MOD2, connected to a switch (H/L).
- Pin 18:** DVSS, connected to ground.
- Pin 19:** MOD1, connected to a switch (H/L).
- Pin 20:** VEH3, connected to a switch (H/L).
- Pin 21:** VEH2, connected to a switch (H/L).
- Pin 22:** VEH1, connected to a switch (H/L).
- Pin 23:** PNR, connected to a switch (H/L).
- Pin 24:** DTR, connected to a switch (H/L).
- Pin 25:** NTPL2, connected to a switch (H/L).
- Pin 26:** NTPL1, connected to a switch (H/L).
- Pin 27:** DVDD, connected to a 0.1μF capacitor.
- Pin 28:** TEST, connected to a 0.1μF capacitor.
- Pin 29:** DVSS, connected to a 0.1μF capacitor.
- Pin 30:** APCN, connected to a switch (H/L).
- Pin 31:** TRAP, connected to a switch (H/L).
- Pin 32:** TEST, connected to a 0.1μF capacitor.
- Pin 33:** TEST, connected to a 0.1μF capacitor.
- Pin 34:** DVDD, connected to a 0.1μF capacitor.
- Pin 35:** TEST, connected to a 0.1μF capacitor.
- Pin 36:** DVSS, connected to a 0.1μF capacitor.

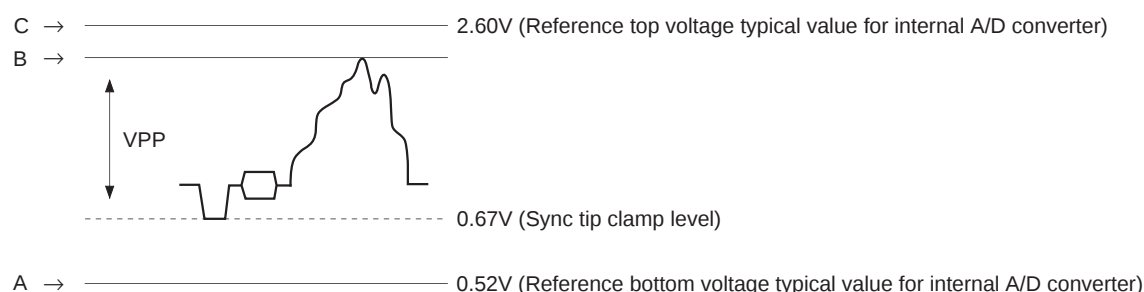
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## Notes on Operation

- Make the wiring for the signal input to ADIN (Pin 2) as short as possible. Also, drive the input signal to ADIN at low impedance.
- Make the analog and digital power supply and GND lines as wide and short as possible to ensure low impedance.
- Bypass the analog and digital power supply pins to GND with a ceramic capacitor of about 0.1μF connected as close to the pin as possible.
- Input a clock that is locked to the burst signal of the input video signal.
- Separate the wiring to the clock input pin FIN (Pin 37) from the external analog circuits, analog power supplies and analog GND.

### • ADIN (analog input signal)

Set the input signal peak-to-peak value VPP to 1.75V or less. Additionally, VPP is recommended to be 1.3V or more since the A/D converter input dynamic range should be made as large as possible.



The DC level at the ADIN pin is as shown in the diagram above when the internal sync tip clamp is used.

Labeling the internal D/A converter AYO output full-scale voltage as VFS, the correspondence between the ADIN pin voltage and AYO output pin voltage (DC level) is as follows;

DC voltage at point B → AYO maximum output voltage [V]

DC voltage at point A → 0 [V]

DC voltage at point C → VFS [V]

The VFS is the AYO output voltage generated when the voltage equivalent to the point C is input.

### • Internal delay

The delay from the internal A/D converter to the D/A converter output is as follows;

NTSC: 1H + 24.5 clocks + αns

PAL: 2H + 24.5 clocks + αns

(α: D/A converter analog output delay = approximately 20ns)

The 24.5 clocks are the sum of the clocks shown below;

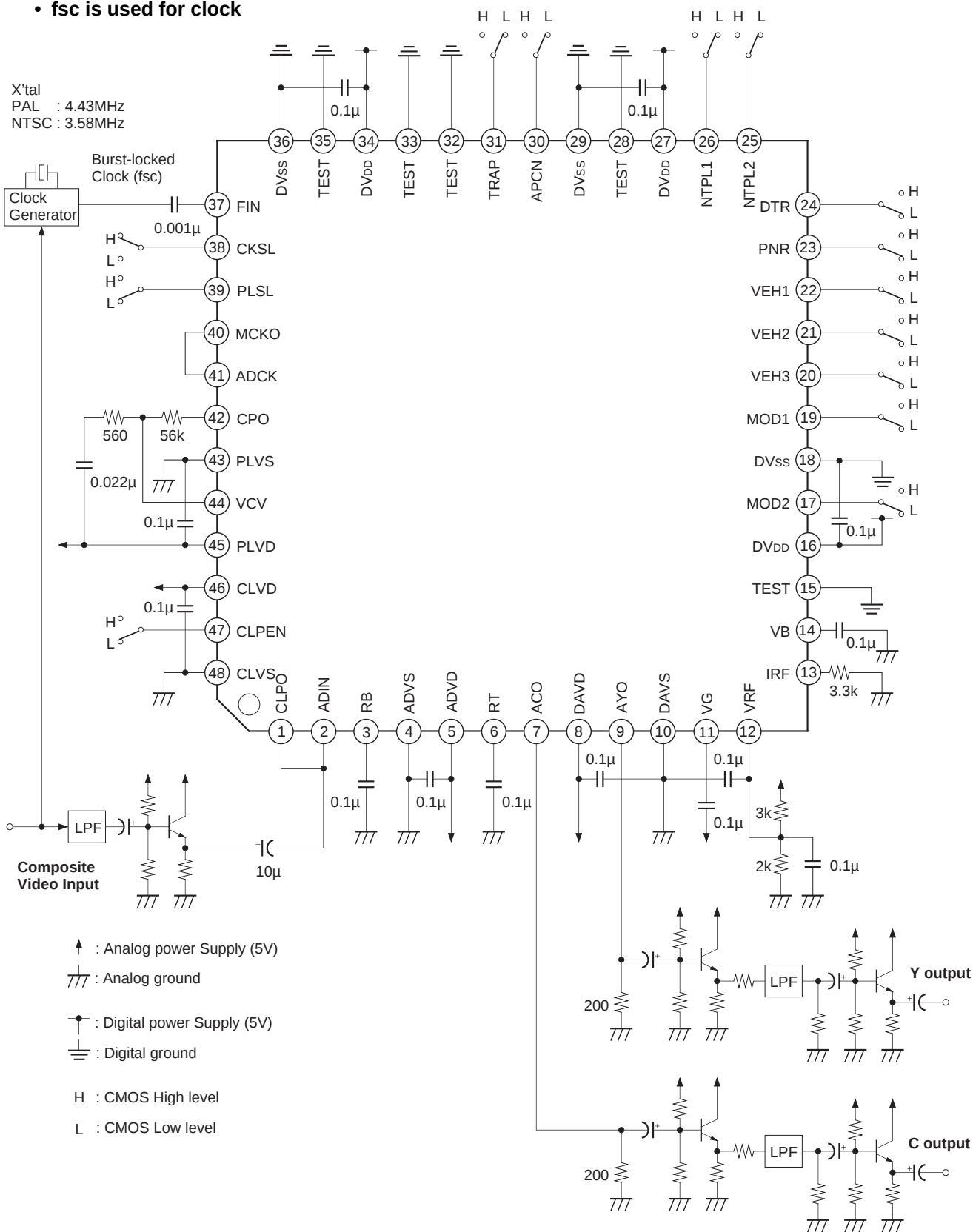
A/D converter: 3.5 clocks ("0.5" is for fetching the data at the fall of the clock.)

Internal logic: 20 clocks

D/A converter: 1 clock

# Application Circuit 1

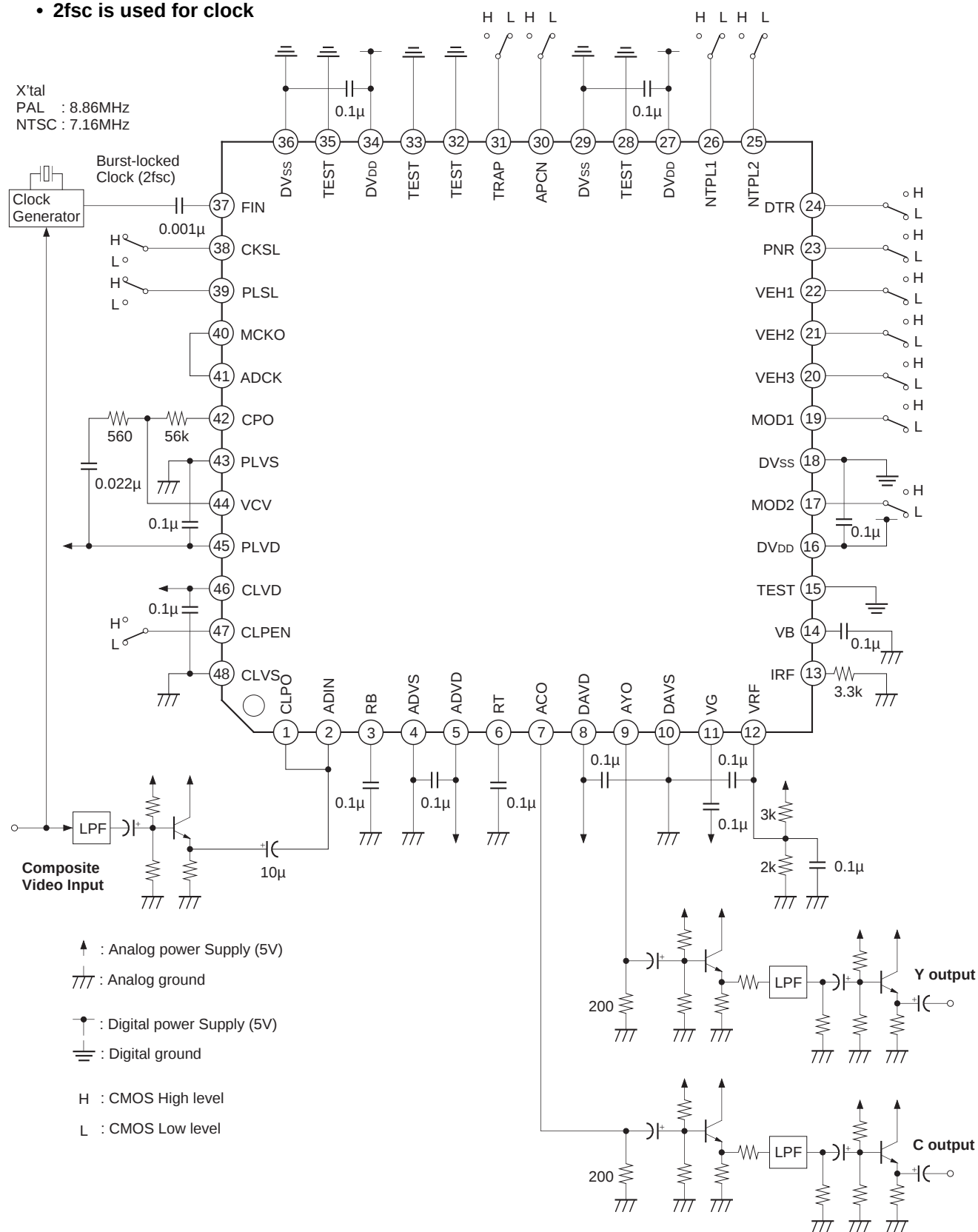
- fsc is used for clock



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

## Application Circuit 2

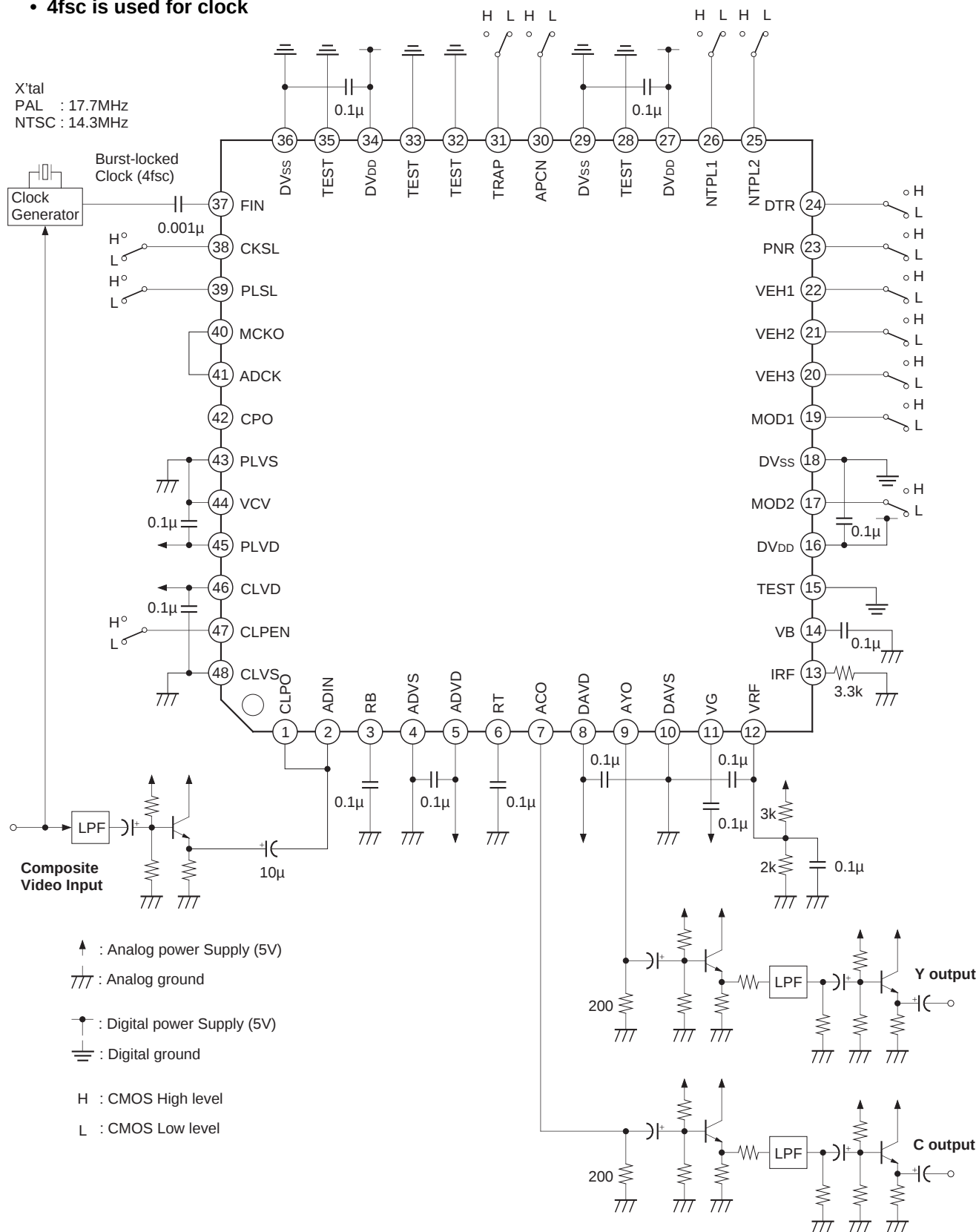
- 2fsc is used for clock



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## Application Circuit 3

- 4fsc is used for clock

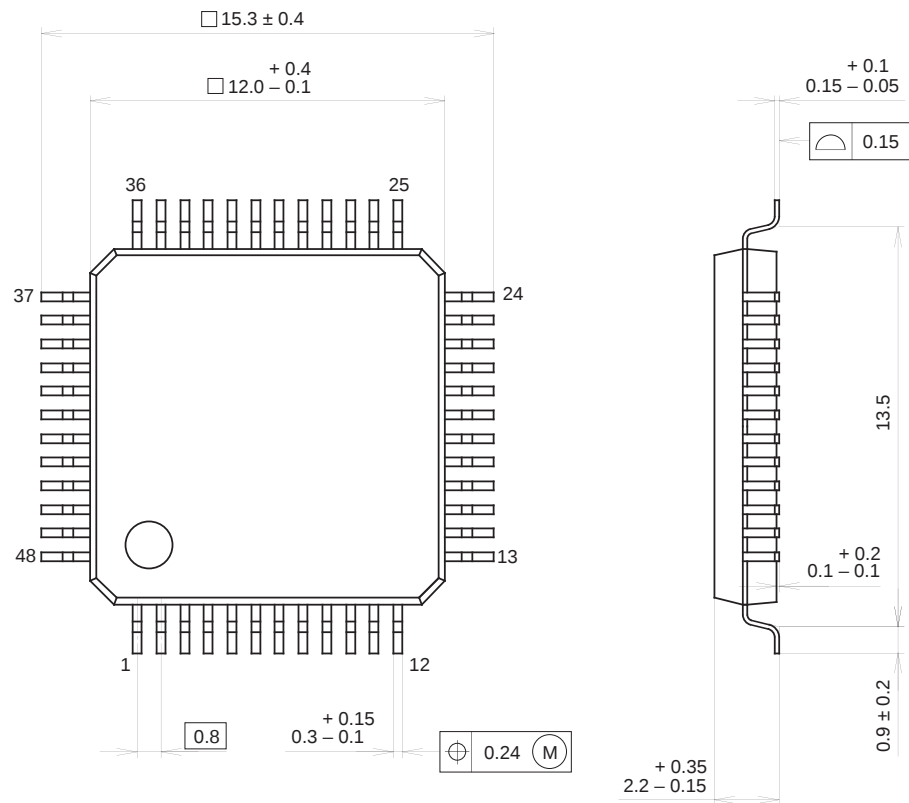


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## Package Outline

Unit : mm

## 48PIN QFP (PLASTIC)



## PACKAGE STRUCTURE

|            |               |
|------------|---------------|
| SONY CODE  | QFP-48P-L04   |
| EIAJ CODE  | QFP048-P-1212 |
| JEDEC CODE | —             |

|                  |                            |
|------------------|----------------------------|
| PACKAGE MATERIAL | EPOXY RESIN                |
| LEAD TREATMENT   | SOLDER / PALLADIUM PLATING |
| LEAD MATERIAL    | 42/COPPER ALLOY            |
| PACKAGE MASS     | 0.7g                       |